

Precision stencil printing.

Just got a lot faster.

MYPro S30™ Stencil Printer





Specifications MYPro S30™

PERFORMANCE	ERFORMANCE	
Machine alignment capability	2≤Cmk @ ±7microns (at 6Sigma) (CNAS certification)	
Process alignment capability	2≤Cpk @ ±15microns (at 6Sigma) (CNAS certification)	
Core cycle time	<7s (exclude printing & cleaning)	
Product changeover time	<5min	
New product set-up time	<10 min	

BOARD HANDLING	
Board size range (mm)	Standard: 50mm×50mm - 510×510mm Optional: 50mm×50mm - 610×510mm
PCB thickness	0.6~6mm (below 0.6mm fixtures are required)
PCB maximum weight	5kg
Stencil frame size (L×W)	470mm×370mm - 780mm×737mm
Stencil thickness	20-40mm
PCB edge clearance	3mm
PCB bottom clearance	Programmable 13mm (23mm optional)
Clamping method	Programmable motorized rear rail Top clamping Side clamping Vacuum clamping
Support method	Magnetic pin Side support block Auto flexible pin (option) ≤1% diagonal

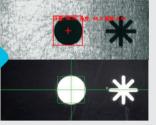
RINTING PARAMETER	
Squeegee type	Steel/rubber squeegee blade (angle 60°/55°/45°)
Squeegee pressure	0-15kg
Printer speed	10~200 mm/s
Snap-off speed	0.01-125mm/s (can be programmed to 3 steps control)
Separation option	Separation after squeegee up; Squeegee up after separation
Conveyor speed	100~1500mm/s
Conveyor direction	$L\rightarrow R, L\rightarrow L, R\rightarrow L, R\rightarrow R$
Table adjustment range	X: ±4mm; Y: ±6mm; 0:±2°
Cleaning system	Drops of rain type cleaning system Dry/Wet/Vacuum modes

OPTICAL SYSTEM		
Field-of-view (FOV)	Standard: 6.4 × 4.8mm (optional 10 × 8mm)	
Fiducial types	Standard shape fiducial, Pad/Hole	
Vision methodology	CCD camera Telecentric concentric vision system Four direction independant views Annular LED lighting source	

FACILITIES REQUIREMENT		
Power supply	AC: 220V±10%, 50/60Hz 1Φ 3kW, 13A	
Air pressure	4-6kg/cm ²	
Air consumption	≈ 0.007 m³/min	
Operation temperature	-20°C ~ +45°C	
Operation humidity	30-60%	
Machine weight	~ 1000kg	
Approximate dimensions	(L)1.250mm × (W)1.440mm × (H)1.510mm	
Operating system	Windows 10	
Acoustic noise level	<87dB	
Certification standards	CE	

STANDARD FEATURES





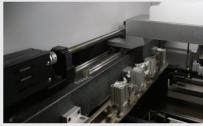
Vision system

The CCD camera performs simultaneous upward and downward inspections, aided by an intelligent adaptive lighting system and an optical ring that ensures uniform and high brightness coaxial lighting. This setup accommodates specialized fiducial marks on any pad, ranging from 0.5mm to 3mm in size. Further flexibility is achieved through multiple light source options, allowing the vision system to seamlessly work with a variety of PCBs.

2D inspection

Experience the benefits of reliable 2D inspection and SPC tools integrated into our stencil printer. With real-time monitoring and meticulous data analysis, our system ensures optimum print quality.

SOLID FOUNDATIONS AND PRECISE CONTROL







Quick stencil positioning stopper

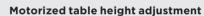
precise positioning while preventing

over-insertion. This intelligent mecha-

nism enhances efficiency by minimizing

setup time and reducing errors during





Enables motorized adaptation to various PCB thicknesses, ensuring flatness and perfect fit for precise printing.

Reliable squeegee system

The squeegee system incorporates a A user-friendly feature that ensures ball-screw mechanism with a servo direct connection, exemplifying a robust design that guarantees reliability and repeatability.



scraper.



the production process.

Close-loop squeegee pressure control Z-axis control

Featuring pressure feedback display, The lifting table is directly connected automatic feedback compensation with servo and ball screw for preciand pressure equalization, this system se control of the lifting position and enhances printing process stability snap-off precision, improving movewhile extending the life of stencil and ment rigidity.

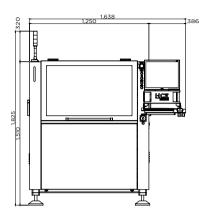


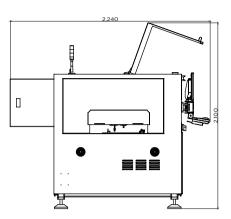
Dry/wet/vacuum cleaning module

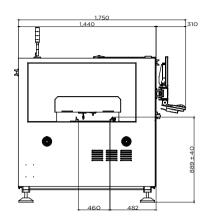
Explore a stencil printer featuring three cleaning methods: dry wipe, wet wipe, and vacuum wipe, offering tailored solutions for diverse cleaning needs. This printer accommodates various cleaning roll paper lengths, ensuring flexibility in application. The precision spray system employs a top-down spray device that dynamically adjusts the spray amount and range based on PCB size, guaranteeing accurate cleaning results.



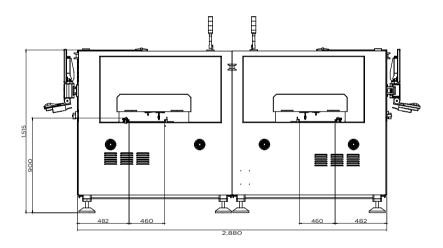
DIMENSIONS [mm]







BACK-TO-BACK POSITIONING



MYCRONIC

MYCRONIC.COM

SWEDEN Mycronic AB PO Box 3141

Nytorpsvägen 9 SE-183 03 Täby

Tel: +46 8 638 52 00

GERMANY Mycronic GmbH Tel: +49 89 45 24 24 8-0

Mycronic Ltd. Tel: +44 1202 723 585

FRANCE Mycronic S.A.S. Tel: +33 1 41 80 15 80

NETHERLANDS

Mycronic B.V. Tel: +31 402 62 06 67

USA

Mycronic Inc. Tel: +1 978 495 9799

SOUTH KOREA

Mycronic Co. Ltd. Tel: +82 31 387 5111

CHINAMycronic Co., Ltd.
Tel: +86 21 3252 3785/86

SINGAPORE

Mycronic Pte Ltd. Tel: +65 6281 7997

JAPAN

Mycronic Technologies Corporation Tel: +81 42 433 9400